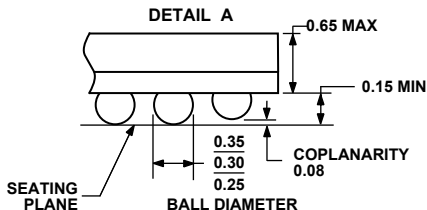
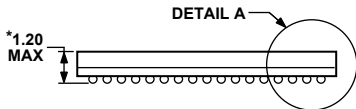
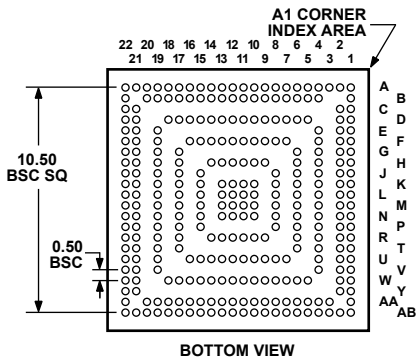
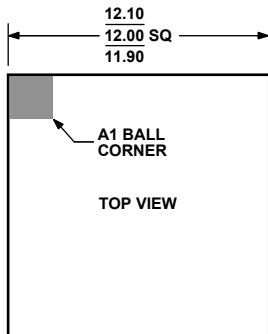


291-Ball Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-291-1)

Dimensions shown in millimeters

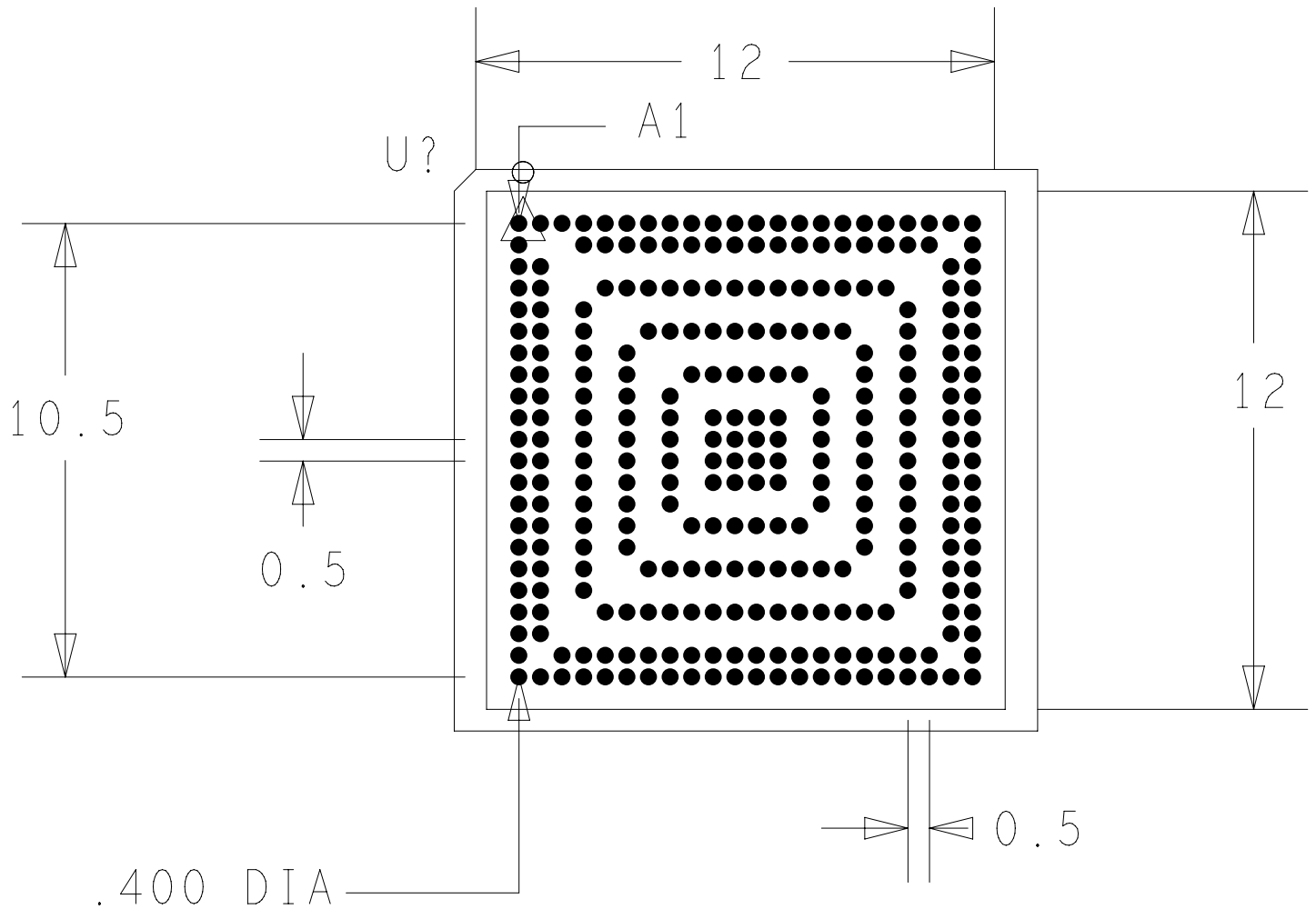


*COMPLIANT TO JEDEC STANDARDS MO-195
WITH THE EXCEPTION TO PACKAGE HEIGHT.

Analog Devices

BC-291-1

REV A



(Dim. are in MM)

LAST MODIFIED 09/14/07